

PRODUCT/ PROCESS CHANGE NOTIFICATION

PRODUCT/ PROCESS CHANGE NOTIFICATION					
1. PCN No.:	QPCN11005				
2. Subject:	KBL 4A, 6A Series,				
	change manufacturing location				
3. To:	All Sales				
4. Issued by:	Owen Wang				
5. Issue date:	23 rd Feb., '11				
6. Proposed first ship date for change:	26 th May, '11				
7. Affected Product Identification					
GPP bridge rectifiers devices: KBL401G thru KBL407G (4A) KBL601G thru KBL607G (6A)					
8. Change Description : (OLD Vs. NEW Con	nparison)				
Old:	New:				
Manufactured at Taiwan Semiconductor YEW plant.	Manufactured at outsource supplier in China.				
9. Reason for Change:					
10. Anticipated Impact: (form, fit, function, quality or reliability) 1. Product outline changed 2. Inner construction changed 3. Electrical specifications: 4. Reliability/performance: 5. Data sheet: 6. Packing code (order code): No change Changing version from E10 to E11 No change					
11.Qualification plan/result:					
efer to PPAP (Please see Appendix C) Comparison data report (Please see Appendix D)					
12. Sample availability Date:	23 rd Feb., '11				
13. Tentative implementation date:	23 rd Feb., '11				
14. Remarks					
Tooth service					
15. Customer feedback required latest: (should we receive no feedback; the change will be deemed as accepted!)	26 th May, '11				
16. Approved by:	Quayer Chen				



PRODUCT/ PROCESS CHANGE NOTIFICATION CUSTOMER APPROVAL FORM_QPCN11005

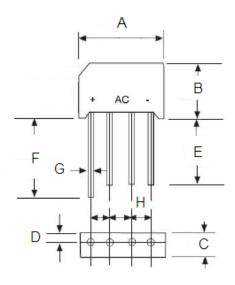
(Please check the appropriate field and provide any comments)

		(1 lease official the appro-	priate field and provide at		
	We agree with this proposed change and its schedule.				
	We have object	ions:			
	We need more	information:			
	We need sampl	les:			
Con	npany:				
Nan	ne:				
Add	lress:				
Sigi	nature:		Date:		

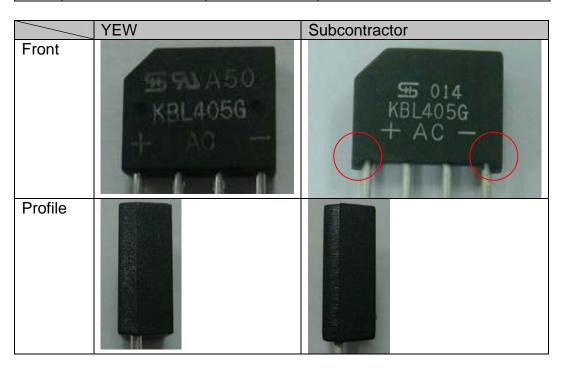


TAIWAN SEMICONDUCTOR PRODUCT/ PROCESS CHANGE NOTIFICATION Annendix

A (Outline dimensions & Appearance):



Item	Dimensions (mm)	YEW (Ave)	Subcontractor (Ave)
Α	18.50 ~ 19.60	19.3	18.97
В	15.37 ~ 16.38	15.81	15.25
С	6.22 ~ 6.48	6.34	5.81
D	1.95 ~ 2.35	2.14	1.98
Е	25.4 MIN	26.48	27.98
F	27.9 MIN	31.41	32.65
G	1.22 ~ 1.32	1.30	1.21
Н	4.83 ~ 5.33	5.08	5.05



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TAIWAN SEMICONDUCTOR PRODUCT/ PROCESS CHANGE NOTIFICATION

Appendix

B (Construction diagrams):

